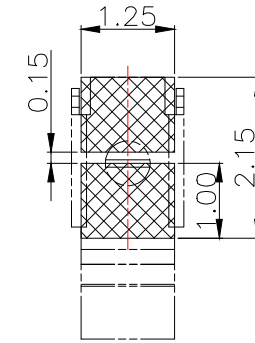
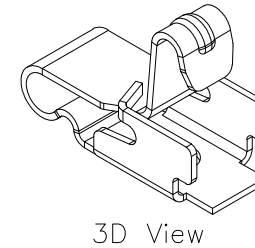
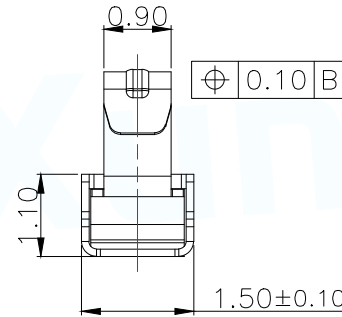
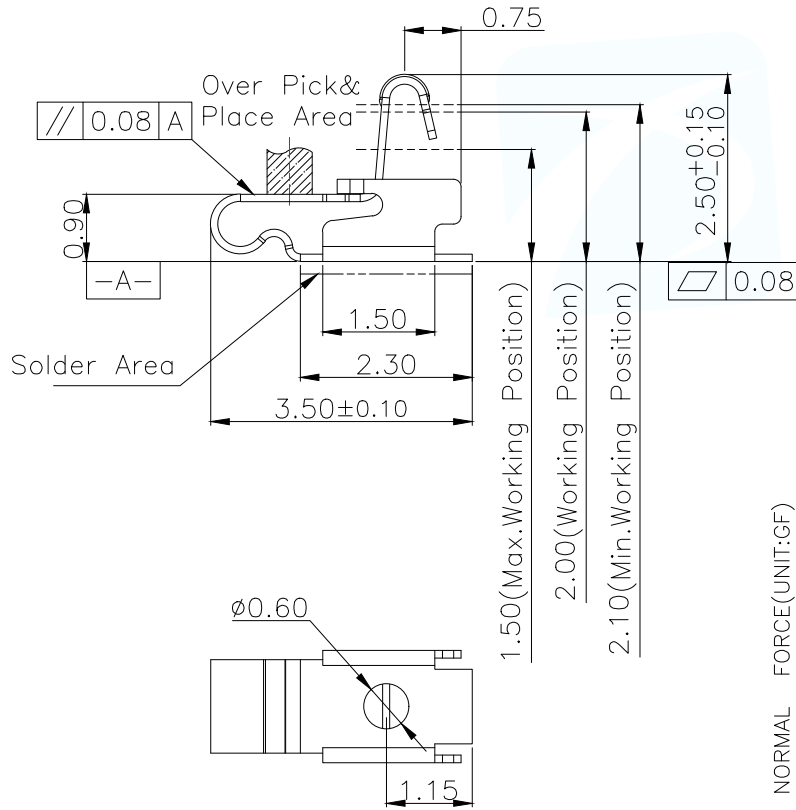
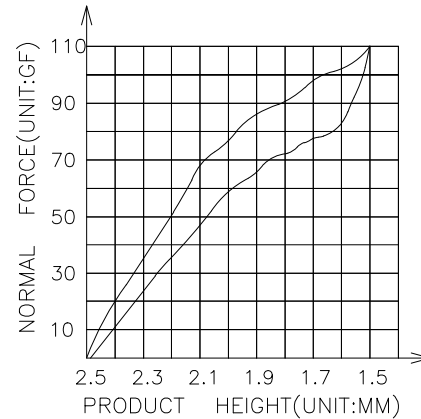


- NOTES:
- 1:MATERIAL
1-1: SUS-304 THICKNE=0.10MM
 - 2:SPECIFICATIONS
2-1: RATED CURRENT: 1.0A
2-2: VOLTAGE RATING: 1.5V
2-3: CONTACT RESISTANCE: 80mΩ/MAX
2-4: WELDING THRUST: ≥3KG
2-5: OPERATING TEMPERATURE: -40°C~+85°C
 - 3:DURABILITY: 1500 CYCLES
 - 4:SALT SPRAY TIME: 24H
 - 5:ELECTROPLATE: THE NICKEL-PLATED SUBSTRATE IS 50u" MIN
 - 6:REQUIREMENTS
6-1:TERMINAL TO EAT FULL TIN,NOTPEELING, WELDING OBVIOUS COLOR AND OTHER ADVERSE
6-2:ROHS.REACH.HF HALOGER ADVERSE OF DOMESTIC AND INTERNATIONAL ENVIRONMNTAL REQUIREMENTS

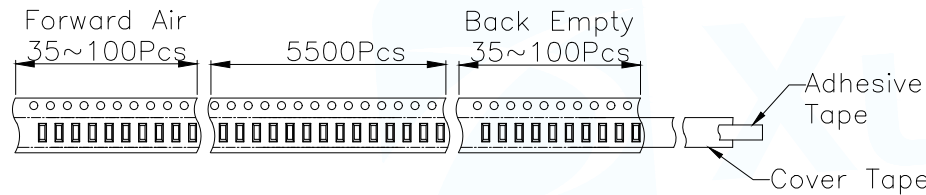
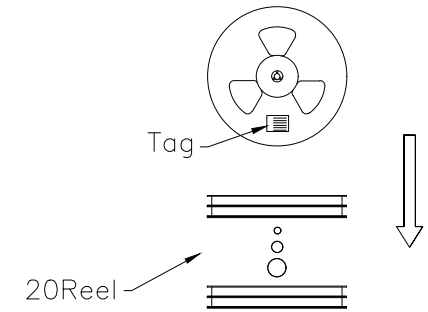
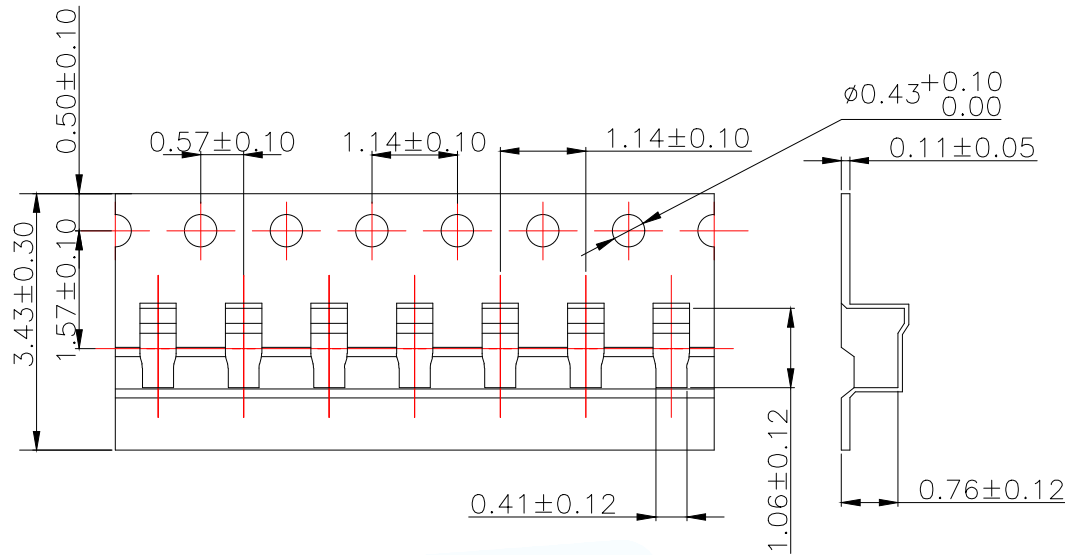


RECOMMENDED PCB LAYOUT
TOLERANCE:±0.05MM (FOR REFERENCE ONLY)



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: 天线弹片 L3.50*W1.50*H2.50
DECIMALS: X.:±0.30			PAR ASP-D2506-A01
ANGLES: X':±2'			DWN Lucas
X.X:±0.20			CHKD Ethan
X.XX:±0.15		X.X':±1'	APVD Jacob
X.XX':±0.5'		CUSTOMER COPY	SCALE:1:1 UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A

12	13	14	15
MAPX	MODIFICATION	DATE	DRAW

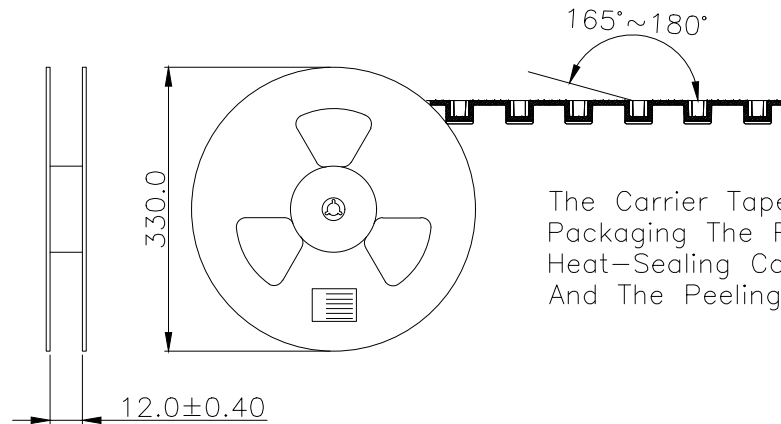


Carton Size
290*330*4 K3K

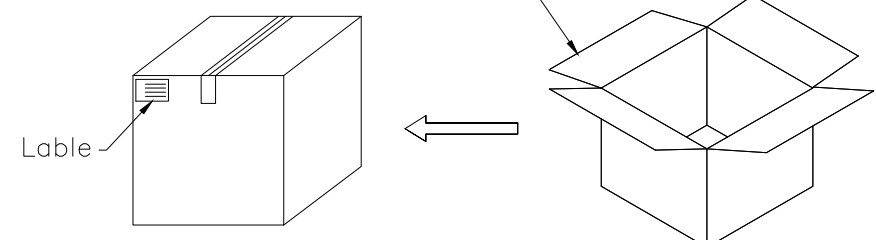
Carton Size
345*345*360 K=K

Customer To Use Direction

Pull Out Direction
(出料方向)



The Carrier Tape Is Heat-Sealed Packaging The Peeling Angle Of The Heat-Sealing Cover Tape Is $165^\circ \sim 180^\circ$ And The Peeling Force Is 30~120g.



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: 天线弹片 L3.50*W1.50*H2.50
			PAR ASP-D2506-A01
DECIMALS:	ANGLES:		DWN Lucas
X.:±0.30	X':±2'		CHKD Ethan
X.X:±0.20	X.X':±1'	APVD Jacob	SCALE:1:1 UNIT:MM
X.XX:±0.15	X.XX':±0.5'	CUSTOMER COPY	SIZE:A4 SHEET:1F1 REV:A

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